PCN Number:		20160211001					PCN Date:		2/18/2016		
Title: Datasheet for									_, _,,		
Customer Contact:								ept: Qua		lity Services	
Cha	nge Typ	e:						_			
	Assemb				Design			Wafer	Bum	p Site	
	Assembly Process			☐ Data Sheet			П	Wafer Bump Material			
Assembly Materials			S		Part number ch	nange	$\overline{\sqcap}$		afer Bump Process		
Mechanical Specification					Test Site		Ħ	Wafer			
Packing/Shipping/Labeling					Test Process		Ħ	Wafer	Fab	Materials	
								Wafer	Fab	Process	
Notification Details											
Description of Change:											
Corr	ection to	the Descr	<mark>iption of Cha</mark>	ange	<mark>9</mark>						
Texas Instruments Incorporated is announcing an information only notification.											
The must detect set(s) is being undeted as supersuited below											
The product datasheet(s) is being updated as summarized below.											
The	following	r change h	istory provid	lec i	further details.						
1116	TOHOWING	g change ii	istory provid	103	urther details.						
- 4	🍒 Ţexas	JMENTS								TRF3765	
•	INSTRU	JMENTS				SLWS230E - SEF	тем	BER 2011-R	EVISED (DECEMBER 2015	
Ch	anges from	Revision D (January 2013) t	o Re	vision E					Page	
_											
Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation											
section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section											
Changed Bit27 through Bit30 of Table 7 From: B[25.21] To: B[3027]											
_						•					
The	datashee	et number	will be chan	aina	1						
Device Family			Change From:						Char	ige To:	
TRF3765					SLWS230D						
110	TRF3765 SLWS230D SLWS230E								3230L		
					datasheet links	provided.					
<u>http</u>	://www.t	<u>i.com/prod</u>	duct/TRF376	<u>5</u>							
Rea	son for	Change									
Reason for Change: To more accurately reflect device characteristics.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.											
to the actual device.											
Changes to product identification resulting from this PCN:											
None.											
	duct Aff	ected:									
_	F3765IRH		TRF3765I	RHF	3T						
TIM 57 OSTMIDIX TIM 57 OSTMIDI											

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com